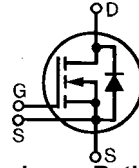


# HiPerFET™ Power MOSFETs

IXFN 200 N06  
IXFN 200 N07

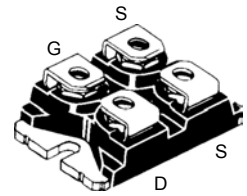
N-Channel Enhancement Mode  
Avalanche Rated, High dv/dt, Low  $t_{rr}$



$V_{DSS}$	$I_{D25}$	$R_{DS(on)}$	
60 V	200 A	6	mΩ
70 V	200 A	6	mΩ

$t_{rr} \leq 250$  ns

miniBLOC, SOT-227 B (IXFN)  
E153432



G = Gate                      D = Drain  
S = Source

Either Source terminal at miniBLOC can be used as Main or Kelvin Source

Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$	N07	70	V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1\text{ M}\Omega$	N06	60	V
$V_{GS}$	Continuous		$\pm 20$	V
$V_{GSM}$	Transient		$\pm 30$	V
$I_{D25}$	$T_C = 25^\circ\text{C}$ ; Chip capability	200N06	200	A
$I_{L(RMS)}$	Terminal current limit	N07	100	A
$I_{DM}$	$T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$		600	A
$I_{AR}$	$T_C = 25^\circ\text{C}$		100	A
$E_{AR}$	$T_C = 25^\circ\text{C}$		30	mJ
$E_{AS}$	$T_C = 25^\circ\text{C}$		2	J
dv/dt	$I_S \leq I_{DM}$ , di/dt $\leq 100$ A/ns, $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$ , $R_{\theta JC} \leq 2^\circ\text{C/W}$		5	V/ns
$P_D$	$T_C = 25^\circ\text{C}$		520	W
$T_J$			-55 ... +150	$^\circ\text{C}$
$T_{JM}$			150	$^\circ\text{C}$
$T_{stg}$			-55 ... +150	$^\circ\text{C}$
$V_{ISOL}$	10/50 Hz, RMS                      t = 1 min $I_{ISOL} \leq 1\text{ mA}$ t = 1 s		2500	V~
			3000	V~
$M_d$	Mounting torque		1.5/13	Nm/lb.in.
	Terminal connection torque		1.5/13	Nm/lb.in.
Weight			30	g

NOT FOR NEW DESIGN

## Features

- International standard packages
- miniBLOC with Aluminium nitride isolation
- Low  $R_{DS(on)}$  HDMOS™ process
- Rugged polysilicon gate cell structure
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
- Fast intrinsic Rectifier

## Applications

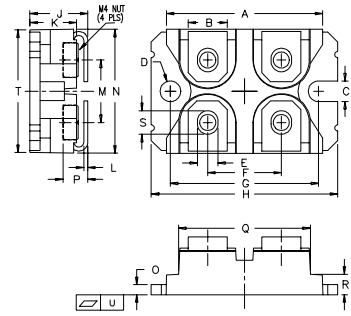
- DC-DC converters
- Synchronous rectification
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- Temperature and lighting controls
- Low voltage relays

## Advantages

- Easy to mount
- Space savings
- High power density

Symbol	Test Conditions		Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
			min.	typ.	max.
$V_{DSS}$	$V_{GS} = 0\text{ V}$ , $I_D = 1\text{ mA}$	N06 N07	60 70		V
$V_{GS(th)}$	$V_{DS} = V_{GS}$ , $I_D = 8\text{ mA}$		2		V
$I_{GSS}$	$V_{GS} = \pm 20\text{ V}_{DC}$ , $V_{DS} = 0$				$\pm 200$ nA
$I_{DSS}$	$V_{DS} = 0.8 \cdot V_{DSS}$ , $T_J = 125^\circ\text{C}$ $V_{GS} = 0\text{ V}$		2		400 $\mu\text{A}$ mA
$R_{DS(on)}$	$V_{GS} = 10\text{ V}$ , $I_D = 0.5 \cdot I_{D25}$ Pulse test, $t \leq 300\text{ }\mu\text{s}$ , duty cycle $d \leq 2\%$				6 mΩ

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$g_{fs}$	$V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$ , pulse test	60	80	S
$C_{iss}$	$V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$		9000	pF
$C_{oss}$			4000	pF
$C_{rss}$			2400	pF
$t_{d(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$ $R_G = 1\ \Omega$ (External),		30	ns
$t_r$			60	ns
$t_{d(off)}$			100	ns
$t_f$			60	ns
$Q_{g(on)}$	$V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$		480	nC
$Q_{gs}$			60	nC
$Q_{gd}$			240	nC
$R_{thJC}$	miniBLOC, SOT-227 B		0.24	K/W
$R_{thCK}$	miniBLOC, SOT-227 B	0.05		K/W

**miniBLOC, SOT-227 B**


M4 screws (4x) supplied

Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	31.50	31.88	1.240	1.255
B	7.80	8.20	0.307	0.323
C	4.09	4.29	0.161	0.169
D	4.09	4.29	0.161	0.169
E	4.09	4.29	0.161	0.169
F	14.91	15.11	0.587	0.595
G	30.12	30.30	1.186	1.193
H	38.00	38.23	1.496	1.505
J	11.68	12.22	0.460	0.481
K	8.92	9.60	0.351	0.378
L	0.76	0.84	0.030	0.033
M	12.60	12.85	0.496	0.506
N	25.15	25.42	0.990	1.001
O	1.98	2.13	0.078	0.084
P	4.95	5.97	0.195	0.235
Q	26.54	26.90	1.045	1.059
R	3.94	4.42	0.155	0.174
S	4.72	4.85	0.186	0.191
T	24.59	25.07	0.968	0.987
U	-0.05	0.1	-0.002	0.004

Symbol	Test Conditions	Characteristic Values ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)		
		min.	typ.	max.
$I_s$	$V_{GS} = 0\text{ V}$		200	A
$I_{SM}$	Repetitive; pulse width limited by $T_{JM}$		600	A
$V_{SD}$	$I_F = 100\text{ A}, V_{GS} = 0\text{ V}$ , Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$		1.7	V
$t_{rr}$	$I_F = 25\text{ A}$ $-di/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 50\text{ V}$		150	250 ns
$Q_{RM}$			0.7	$\mu\text{C}$
$I_{RM}$			9	A

IXYS reserves the right to change limits, test conditions, and dimensions.



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